# 74AHC245-Q100; 74AHCT245-Q100

Octal bus transceiver; 3-state

Rev. 3 — 21 September 2023

Product data sheet

### 1. General description

The 74AHC245-Q100; 74AHCT245-Q100 is an 8-bit transceiver with 3-state outputs. The device features an output enable ( $\overline{OE}$ ) and send/receive (DIR) for direction control. A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- · Balanced propagation delays
- All inputs have Schmitt-trigger action
- Overvoltage tolerant inputs to 5.5 V
- · High noise immunity
- · CMOS low power dissipation
- Input levels:
  - For 74AHC245-Q100: CMOS level
  - For 74AHCT245-Q100: TTL level
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- · Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

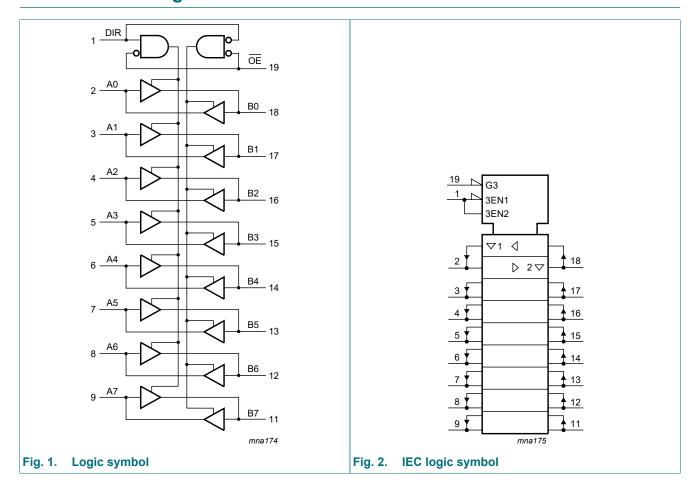
### 3. Ordering information

**Table 1. Ordering information** 

Type number	Package								
	Temperature range	Name	Description	Version					
74AHC245D-Q100 74AHCT245D-Q100	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74AHC245PW-Q100 74AHCT245PW-Q100	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74AHC245BQ-Q100 74AHCT245BQ-Q100	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1					

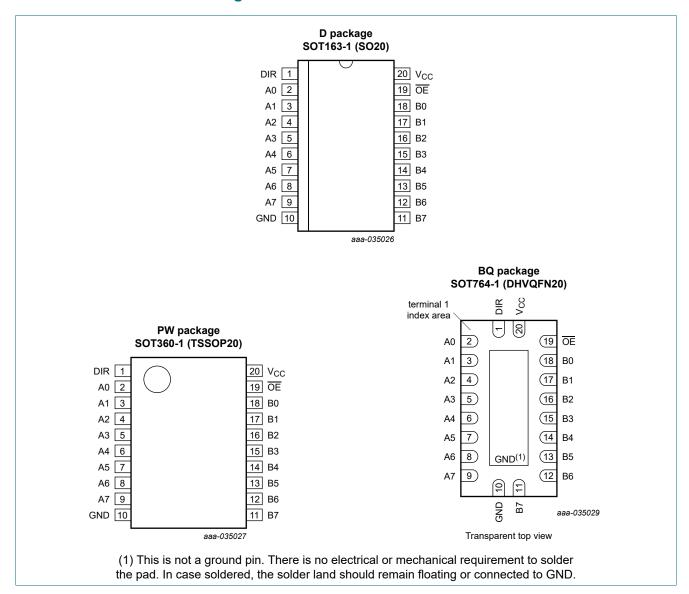


### 4. Functional diagram



### 5. Pinning information

### 5.1. Pinning



#### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
DIR	1	direction control input
A0, A1, A2, A3, A4, A5, A6, A7	2, 3, 4, 5, 6, 7, 8, 9	data input/output
GND	10	ground (0 V)
B0, B1, B2, B3, B4, B5, B6, B7	18, 17, 16, 15, 14, 13, 12, 11	data input/output
ŌĒ	19	output enable input (active LOW)
V <sub>CC</sub>	20	supply voltage

### 6. Functional description

#### Table 3. Function table

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't care; Z = high-impedance OFF-state.}$ 

Control		Input/output				
DE DIR		An	Bn			
L	L	A = B	inputs			
L	Н	inputs	B = A			
Н	X	Z	Z			

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	[1]	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	[1]	-20	+20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-25	+25	mA
I <sub>CC</sub>	supply current			-	+75	mA
I <sub>GND</sub>	ground current			-75	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT360-1 (TSSOP20) package: Ptot derates linearly with 10.0 mW/K above 100 °C.

For SOT764-1 (DHVQFN20) package: Ptot derates linearly with 12.9 mW/K above 111 °C.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter Conditions		74AHC245-Q100			74AHCT245-Q100			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-	-	100	-	-	-	ns/V
	fall rate	$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	-	-	20	-	-	20	ns/V

<sup>[2]</sup> For SOT163-1 (SO20) package: Ptot derates linearly with 12.3 mW/K above 109 °C.

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC2	45-Q100							1		
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	$I_O = -50 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O}$ = -50 $\mu$ A; $V_{CC}$ = 3.0 $V$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O}$ = -8.0 mA; $V_{CC}$ = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	$I_{O} = 50 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \mu A; V_{CC} = 3.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.25	-	±2.5	-	±10.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
C <sub>I</sub>	input capacitance	V <sub>I</sub> = V <sub>CC</sub> or GND	-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHCT	245-Q100									'
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub> HIGH-level		$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
output voltage	Ι <sub>Ο</sub> = -50 μΑ	4.4	4.5	-	4.4	-	4.4	-	V	
	I <sub>O</sub> = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V	
V <sub>OL</sub> LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$									
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.25	-	±2.5	-	±10.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$ ; other pins at $V_{CC}$ or GND; $I_O = 0 \text{ A}$ ; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
C <sub>I</sub>	input capacitance	V <sub>I</sub> = V <sub>CC</sub> or GND	-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	1
74AHC2	45-Q100							-		
t <sub>pd</sub>	propagation delay	An to Bn; Bn to An; [2] see Fig. 3								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.0	8.4	1.0	10.0	1.0	10.5	ns
		C <sub>L</sub> = 50 pF	-	6.5	11.9	1.0	13.5	1.0	15.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	3.5	5.5	1.0	6.5	1.0	7.0	ns
		C <sub>L</sub> = 50 pF		5.0	7.5	1.0	8.5	1.0	9.5	ns
t <sub>en</sub> enable time	OE to An; OE to Bn; [3] see Fig. 4									
	V <sub>CC</sub> = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF	-	6.5	13.2	1.0	15.5	1.0	16.5	ns
		C <sub>L</sub> = 50 pF	-	9.0	16.7	1.0	19.0	1.0	21.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.0	8.5	1.0	10.0	1.0	11.0	ns
		C <sub>L</sub> = 50 pF	-	5.0	10.6	1.0	12.0	1.0	13.5	ns
t <sub>dis</sub>	disable time	OE to An; OE to Bn; [4] see Fig. 4								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	7.5	12.5	1.0	15.5	1.0	16.0	ns
		C <sub>L</sub> = 50 pF	-	10.0	15.8	1.0	18.0	1.0	20.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.5	7.8	1.0	9.2	1.0	10.0	ns
		C <sub>L</sub> = 50 pF	-	6.0	9.7	1.0	11.0	1.0	12.5	ns
C <sub>PD</sub>	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_i = \text{GND to } V_{CC}$ [5]	-	12	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74AHCT	245-Q100; V <sub>CC</sub>	= 4.5 V to 5.5 V								
t <sub>pd</sub>	propagation delay	An to Bn; Bn to An; [2] see Fig. 3								
		C <sub>L</sub> = 15 pF	-	3.5	7.7	1.0	8.5	1.0	10.0	ns
		C <sub>L</sub> = 50 pF	-	4.5	8.7	1.0	9.5	1.0	11.0	ns
t <sub>en</sub>	enable time	OE to An; OE to Bn; [3] see Fig. 4								
		C <sub>L</sub> = 15 pF	-	5.0	13.8	1.0	15.0	1.0	17.5	ns
		C <sub>L</sub> = 50 pF	-	6.0	14.8	1.0	16.0	1.0	18.5	ns
t <sub>dis</sub>	disable time	OE to An; OE to Bn; [4] see Fig. 4								
		C <sub>L</sub> = 15 pF	-	5.0	14.4	1.0	15.5	1.0	18.0	ns
		C <sub>L</sub> = 50 pF	-	6.0	15.4	1.0	16.5	1.0	19.5	ns
C <sub>PD</sub>	power dissipation capacitance	$f_i = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$ [5]	-	15	-	-	-	-	-	pF

- Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V and  $V_{CC}$  = 5.0 V).
- [2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.
- [3]  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .
- [4] t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.
   [5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).
   P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N + Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_i \times V_{CC}^2 \times f_o)$$
 where:

 $f_i$  = input frequency in MHz;

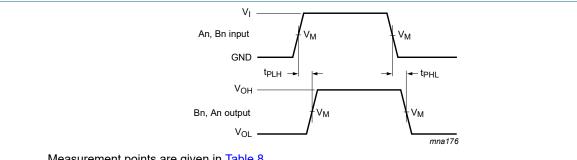
f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^{\ 2} \times f_o) = \text{sum of the outputs}.$ 

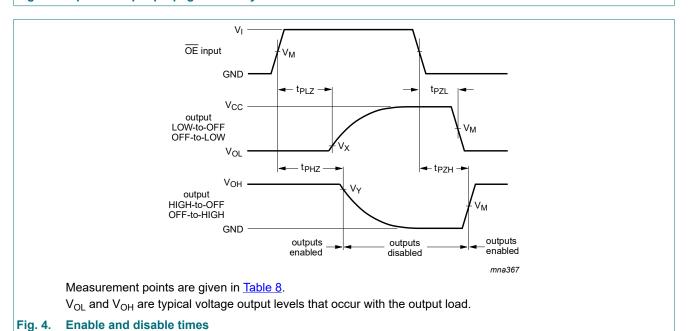
#### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

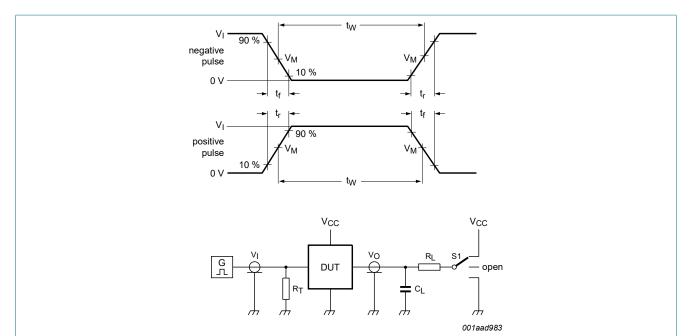
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Input to output propagation delays Fig. 3.



**Table 8. Measurement points** 

Туре	Input	Output						
	V <sub>M</sub>	V <sub>M</sub>	$V_X$	V <sub>Y</sub>				
74AHC245-Q100	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V				
74AHCT245-Q100	1.5 V	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V				



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch.

#### Fig. 5. Test circuit for measuring switching times

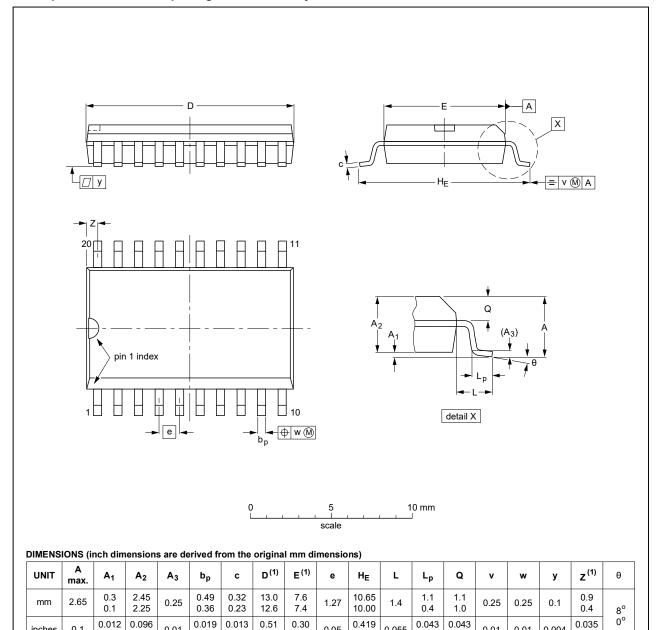
Table 9. Test data

Туре	Input		Load		S1 position		
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$
74AHC245-Q100	V <sub>CC</sub>	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74AHCT245-Q100	3.0 V	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>

### 11. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



inches

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.019

0.014

0.013

0.009

0.51

0.49

0.30

0.29

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

0.05

0.394

0.043

0.039

0.01

0.01

0.004

0.016

0.043

0.016

0.055

Fig. 6. Package outline SOT163-1 (SO20)

0.012

0.004

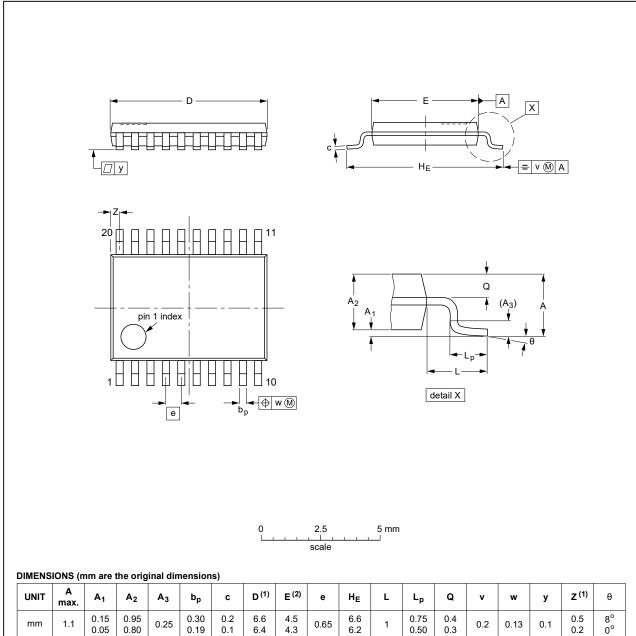
0.096

0.089

0.01

#### TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT360-1		MO-153				<del>99-12-27</del> 03-02-19

Fig. 7. Package outline SOT360-1 (TSSOP20)

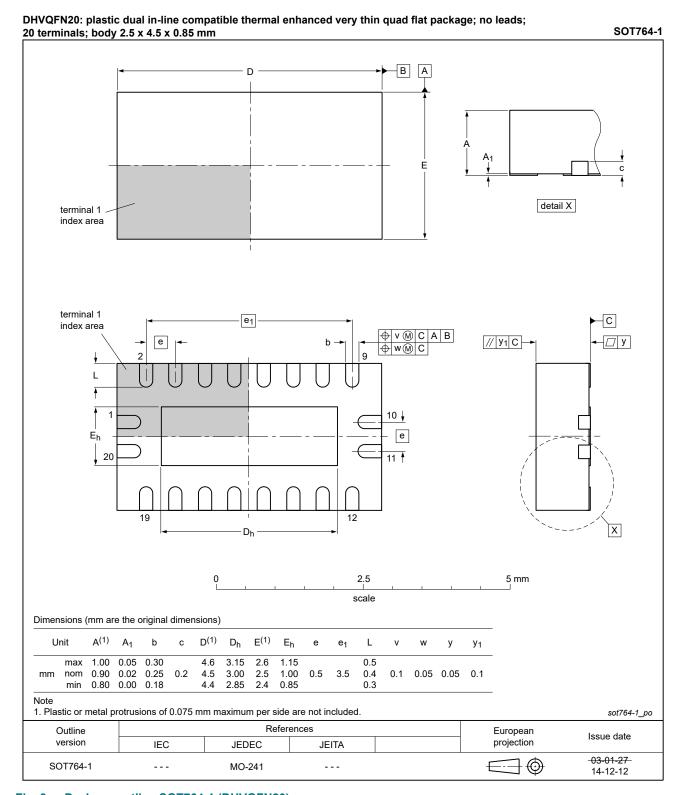


Fig. 8. Package outline SOT764-1 (DHVQFN20)

### 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AHC_AHCT245_Q100 v.3	20230921	Product data sheet	-	74AHC_AHCT245_Q100 v.2	
Modifications:	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74AHC_AHCT245_Q100 v.2	20200703	Product data sheet	-	74AHC_AHCT245_Q100 v.1	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 1 and Section 2 updated.</li> <li>Table 4: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> <li>Table 6: Conditions for I<sub>OZ</sub> corrected.</li> <li>Package outline drawing of SOT764-1 (Fig. 8) updated.</li> </ul>				
74AHC_AHCT245_Q100 v.1	20130321	Product data sheet	-	-	

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

#### **Definitions**

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### **Contents**

1. General description	1
2. Features and benefits	1
3. Ordering information	1
4. Functional diagram	2
5. Pinning information	3
5.1. Pinning	3
5.2. Pin description	3
6. Functional description	4
7. Limiting values	4
8. Recommended operating conditions	4
9. Static characteristics	5
10. Dynamic characteristics	7
10.1. Waveforms and test circuit	9
-	
10.1. Waveforms and test circuit	11
10.1. Waveforms and test circuit	11 14

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